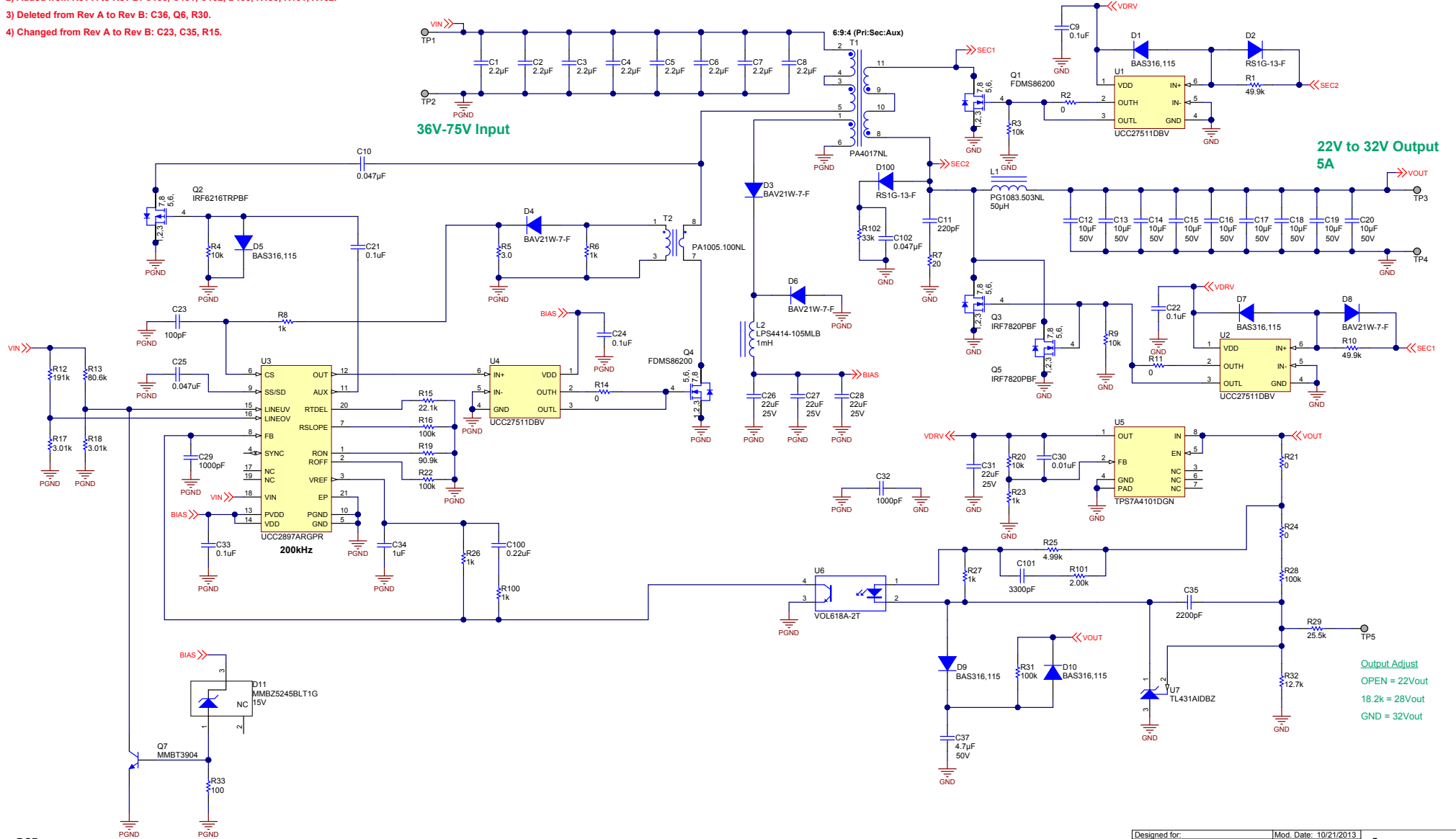


**Notes:**

- 1) Built using PMP9127 Rev A PCB.
- 2) Added from Rev A to Rev B: C100, C101, C102, D100, R100, R101, R102.
- 3) Deleted from Rev A to Rev B: C36, Q6, R30.
- 4) Changed from Rev A to Rev B: C23, C35, R15.



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Number: PMP9127	Rev: B	Designed for: Project Title: 36V-75Vin, 22V-32V/5A Output Active Clamp	Mod. Date: 10/21/2013
SVN Rev: Not in version control	Assembly Variant: 001	Sheet Title:	Sheet: 1 of 1
Drawn By:	Engineer: B King	File: PMP9127_REV.B_SchDoc	Size: B
		Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	

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